

一体成型功率电感

Data Sheet



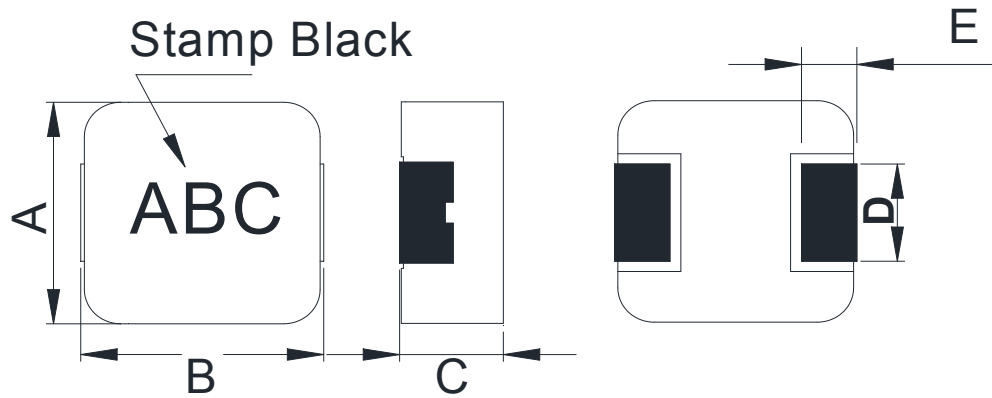
SPECIFICATION

			AMENDMENT RECORD			
SYMBOL	DATE	PAGE	CONTENTS	DWN. BY	CHK. BY	APP. BY
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SPECIFICATION

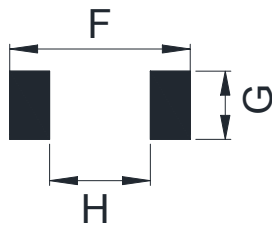
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1. DIMENSIONS (UNIT : mm)



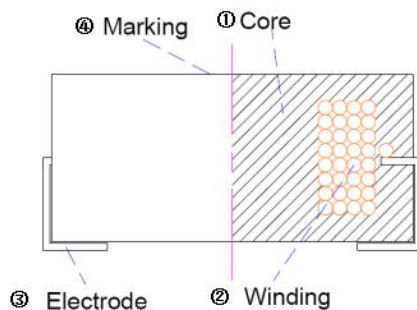
A	B	C	D	E
6.6±0.3	7.1 ±0.3	5.0 MAX	3.0 ±0.3	1.6 ±0.5

2. RECOMMENDED LAND PATTERN (UNIT: mm)



F	8.4 Ref.
G	3.5 Ref.
H	3.7 Ref.

3. STRUCTURE



No.	PARTS	MATERIAL
①	CORE	Alloy powder
②	WIRE	Self bonding polyamide-imide enameled Copper Wire
③	ELECTRODE	Cu
④	MARKING	INK

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4.CHARACTERISTICS

No.	P/N.	Inductance (μ H)	Stamp	D.C.R. (m Ω) Max.	Saturation Current (A)		Temperature rise current($\Delta T \leq 40^\circ\text{C}$) (A).	
					Typ	MAX	Typ	MAX
01	D0650HP-1R5MT	1.5 $\pm$ 20%	1R5	8.5	10	8.5	10	8.5

* Testing instrument: Inductance HP 4284A or equivalent at 100KHz /1V..

D.C.R : TH2512B or equivalent. ($T_a = 25^\circ\text{C}$)

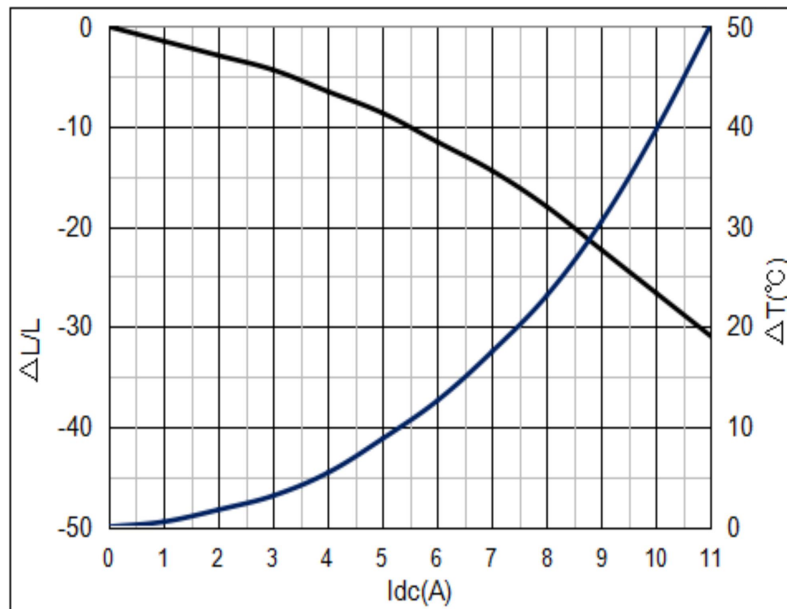
Saturation current: WK 3260B+3265B or equivalent.

* Saturation current: indicates the current when the inductance decrease to approximately 70% of initial value. ($T_a = 25^\circ\text{C}$)

* The temperature rise current value is the DC current value having temperature increase up to approximately 40°C ($T_a = 25^\circ\text{C}$)

* Absolute maximum voltage 30VDC

1R5 DC Bias & Temperature Characteristics



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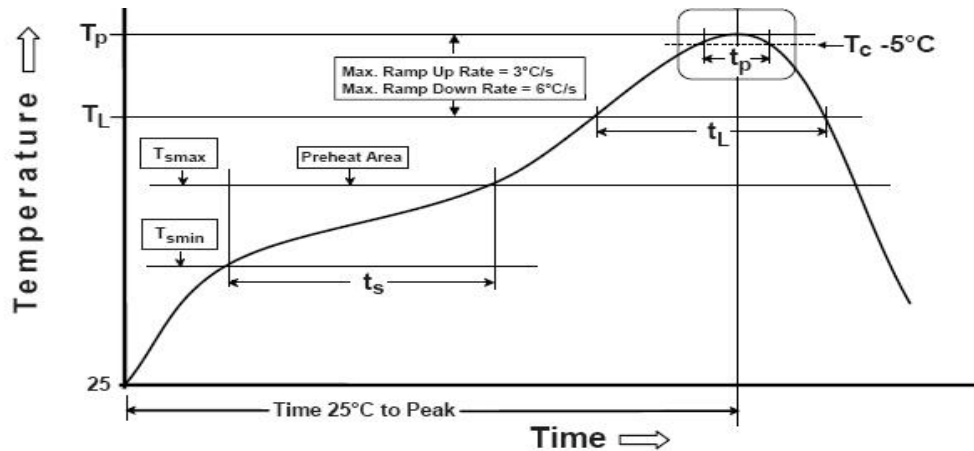
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5.<u>GENERAL CHARACTERISTICS</u> * STANDARD TESTING CONDITIONS: UNLESS OTHERWISE SPECIFIED, THE STANDARD RANGE OF ATMOSPHERIC CONDITIONS FOR MEASUREMENTS AND TESTS ARE AS FOLLOWS: AMBIENT TEMPERATURE: 15℃~35℃. RELATIVE HUMIDITY : 25% ~85%. AIR PRESSURE : 86kPa ~106kPa. IF THERE IS ANY DOUBT ABOUT THE RESULTS, MEASUREMENT SHALL BE MADE WITHIN THE FOLLOWING LIMITS: AMBIENT TEMPERATURE: 20℃±1℃. RELATIVE HUMIDITY: 63% ~67%. AIR PRESSURE : 86kPa ~106kPa.							
No.	ITEMS		CONDITIONS		SPECIFICATION		
1	OPERATION TEMPERATURE STORAGE TEMPERATURE				-40 ~ + 125℃ (INCLUDING COIL TEMPERATURE RISE) -40 ~ + 125℃		
2	TEMPERATURE COEFFICIENT		-30 ~ +105℃		0 ~ 2000 ppm/℃		
3	FIXING STRENGTH		SAMPLE IS PUSHED IN THREE DIRECTIONS OF X, Y AND Z WITH FORCE OF 5. 0N FOR 10±5 SECONDS. AFTER SOLDERING BETWEEN COPPER PLATE AND ELECTRODES.		NO ELECTRODE DETACHMENT.		
4	RESISTANCE TO SOLDERING HEAT TEST		REFER TO THE SPEC “STD-001NP”.		NO MECHANICAL BREAKAGE. DEVIATION RELATIVE TO INITIAL VALUE: L: WITHIN ±10%		
5	SOLDERABILITY TEST		IMMERSE THE ELECTRODE IN FLUX FOR 5 SECONDS. THEN DIP THE ELECTRODE INTO A SOLDERING BATH OF 245±5℃ FOR 2±0.5 SECONDS.		OVER 95% OF THE SURFACE BEING IMMersed SHALL BE COVERED WITH NEW SOLDER UNIFORMLY.		
6	VIBRATION TEST		AMPLITUDE: 1.5mm P-P FREQUENCY:10~55~10Hz (1 MINUTE PER CYCLE) DURATION: 1 HOUR IN EACH OF X, Y, Z AXIS.		DEVIATION RELATIVE TO INITIAL VALUE: L: WITHIN ±10%		
7	HUMIDITY TEST		TEMPERATURE: 40℃±2℃ HUMIDITY: 90%~95%RH DURATION: 96±4 HOURS.		DEVIATION RELATIVE TO INITIAL VALUE: L: WITHIN ±10%		
8	THERMAL SHOCK TEST		20 CYCLES OF +105℃ FOR 30 MINUTES, -40℃ FOR 30 MINUTES. CHARACTERISTICS ARE MEASURED AFTER THE AMBIENT AIR EXPOSURE OF 1 HOUR		DEVIATION RELATIVE TO INITIAL VALUE: L: WITHIN ±10%		
9	HIGH TEMPERATURE STORAGE TEST		TEMPERATURE: 125℃±2℃ DURATION: 96±4 HOURS				
10	LOW TEMPERATURE STORAGE TEST		TEMPERATURE: -40℃±3℃ DURATION: 96±4 HOURS.				
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. Reflow profile for SMT components



Reflow is referred to standard IPC/ JEDEC J-STD-020D

Profile Feature		Lead(Pb) Free solder
Preheat and soak	·temperature Min.(T _{smin})	150°C
	·temperature Max.(T _{smax})	200°C
	·time(T _{smin} to T _{smax})(t _s)	60-120 Seconds
Average ramp up rate T _{smax} to T _p		3°C/Second Max.
Liquidous temperature (T _L)		217 °C
Time (T _L) maintained above T _L		60-150 seconds
Peak package body temperature (T _p)		Table2
Time (tp)* within 5 °C of the specified classification temperature (T _c)		30* seconds
Average Ramp-down rate (T _p to T _L)		6 °C/second max
Time 25 °C to peak temperature		8 minutes max.

Table2. Pb-Free Process - Classification Temperatures (T_c)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350~2000	Volume mm ³ >2000
<1.6 mm	260°C	260°C	260°C
1.6mm- 2.5mm	260°C	250°C	245°C
>2.5 mm	250°C	245°C	245°C

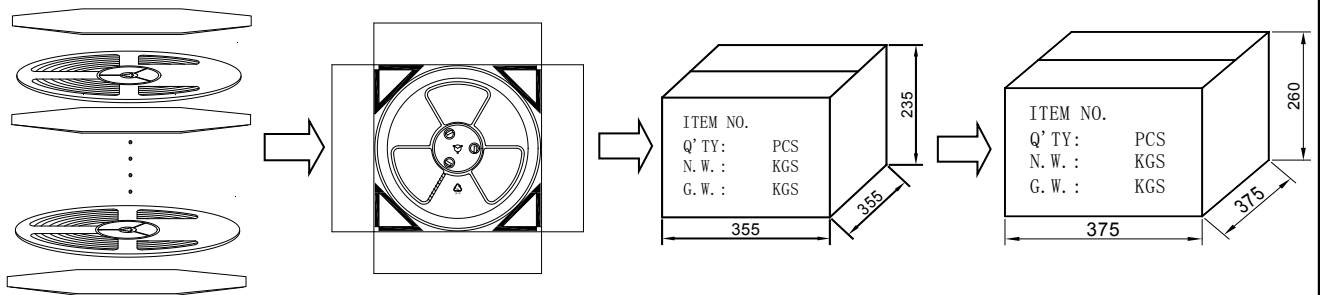
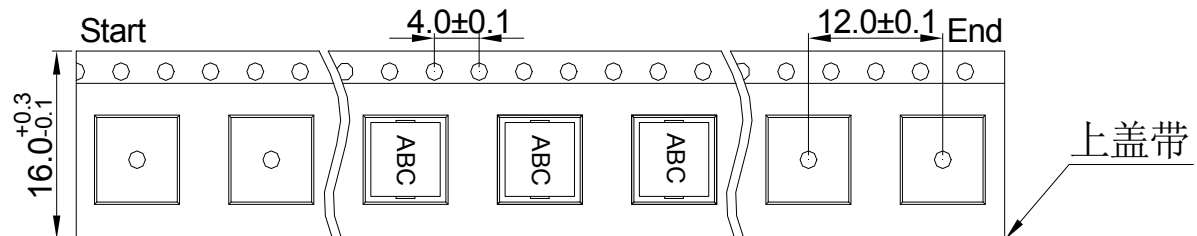
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7. PACKING

REFER TO STANDARD PACKING DRAWING. 1000PCS/R



REEL	1000PCS
BOX	8000PCS

8. NOTE

SOLDERING TIN PERIOD OF VALIDITY: SIX MONTHS
 STORAGE TEMPERATURE: $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$
 COMPARATIVELY HUMIDITY: 35%--70%

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